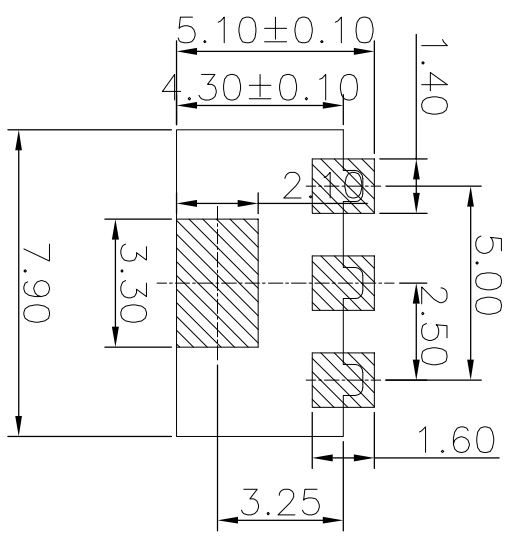
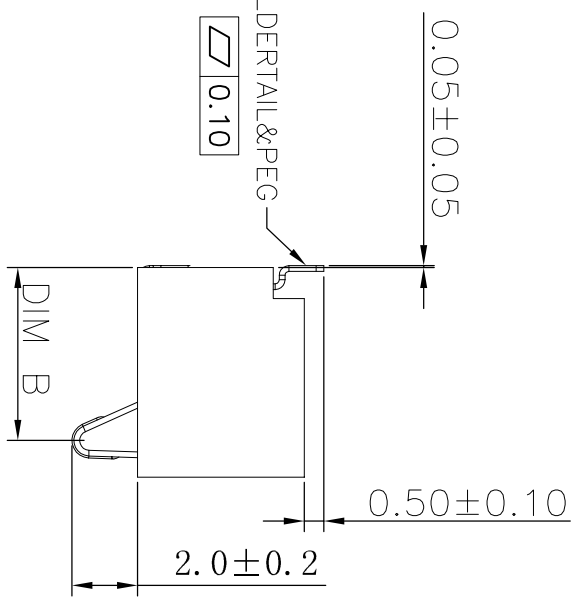
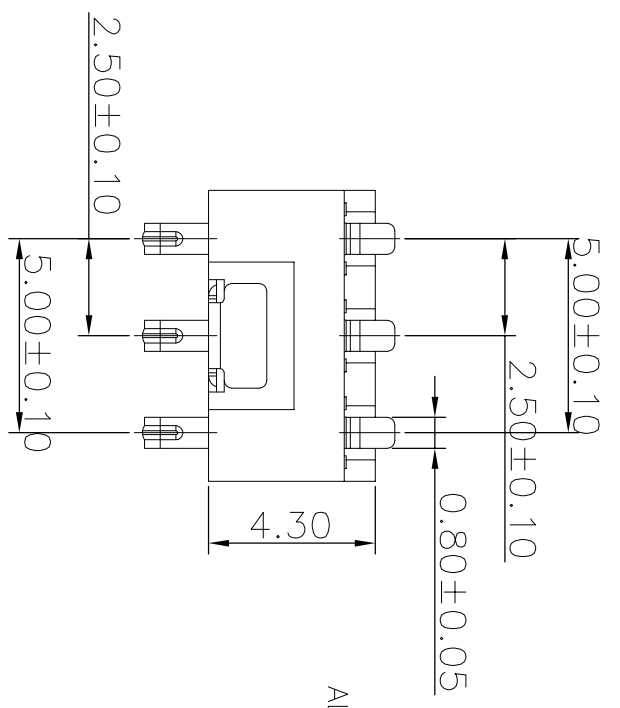
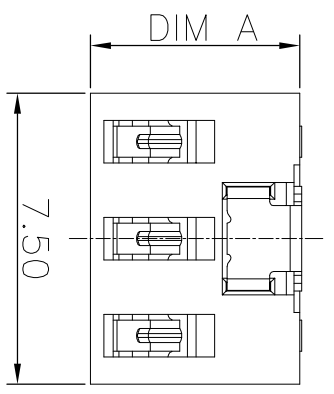


REV.	ECN NO.	MODIFY CONTENT	DATE
A		NEW	2011/10/31



RECOMMENDED PCB LAYOUT
TOP VIEW (.XX±0.05)



- NOTES:
 1. HOUSING MATERIAL: LCP BLACK UL 94V-0
 2. CONTACT MATERIAL: COPPER ALLOY.
 FINISH: NICKEL UNDERPLATED, GOLD PLATING ON CONTACT AREA, TIN PLATING ON SOLDER AREA
 3. NAIL MATERIAL: COPPER ALLOY.
 FINISH: NICKEL UNDERPLATED, PLATED TIN OVER ALL.

PART NO.	H=?	DIM A	DIM B	GENERAL TOLERANCE		DWG NO.	APPD:	WIND	Scale			
				X±0.45	X±0.5							
JYS-BY540-073B	5.4	5.4	4.4	X±0.35	X±2°	JYSA0405-04	BATTERY 3PIN 2.50PITCH 5.4H-8.0H WITHOUT POST		UNIT			
JYS-BY600-074B	6.0	6.0	4.7	.XX±0.25	.XX±1°					SEE TABLE	Date	mm
JYS-BY650-053B	6.5	6.5	5.2	.XXX±0.15	.xxx±0.5°							
JYS-BY700-100B	7.0	7.0	5.6	SHEET	1/1							
JYS-BY800-101B	8.0	8.0	6.7									

杰宇森电子有限公司
 JIE YU SEN ELECTRONIC CO., LTD.